

## Features

- $BV_{CEO} > -20V$
- $I_C = -2A$  High Continuous Collector Current
- $R_{CE(SAT)} = 100m\Omega$  for a Low Equivalent On-Resistance
- Low Saturation Voltage  $V_{CE(SAT)} < -150mV @ -1A$
- Sidewall Tin Plating for Wettable Flanks in AOI
- $P_D$  up to 2.47W for Power Demanding Applications
- Low Profile 0.6mm High Package for Thin Applications
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**
- **PPAP Capable (Note 4)**

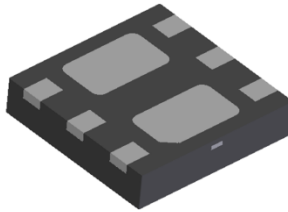
## Mechanical Data

- Case: U-DFN2020-6 (SWP) (Type A) with Sidewall Plating (SWP)
- Case Material: Molded Plastic. "Green" Molding Compound. UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish — Matte Tin, Solderable per MIL-STD-202, Method 208
- Weight: 0.0065 grams (Approximate)

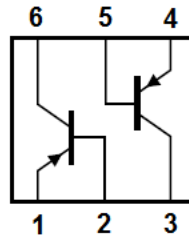
## Application

- Matrix LED Lighting
- Power Management

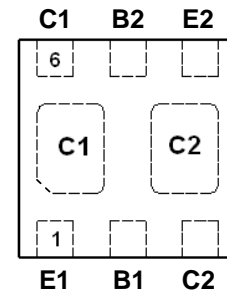
U-DFN2020-6 (SWP) (Type A)



Bottom View



Device Symbol



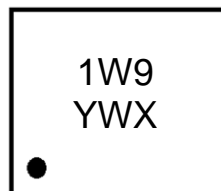
Top View  
Pin-Out

## Ordering Information (Notes 4 & 5)

| Part Number     | Marking | Reel Size (inches) | Tape Width (mm) | Quantity Per Reel |
|-----------------|---------|--------------------|-----------------|-------------------|
| ZXTP56020FDBQ-7 | 1W9     | 7                  | 8               | 3,000             |

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
  2. See [http://www.diodes.com/quality/lead\\_free.html](http://www.diodes.com/quality/lead_free.html) for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to [http://www.diodes.com/product\\_compliance\\_definitions.html](http://www.diodes.com/product_compliance_definitions.html).
  5. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

## Marking Information



1W9 = Product Type Marking Code  
 Y = Year: 0~9  
 W = Week: A~Z: 1~26 week;  
 a~z: 27~52 week; z represents  
 52 and 53 week  
 X = A~Z: Internal Code

**Absolute Maximum Ratings – Q1 & Q2** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic               | Symbol           | Value | Unit |
|------------------------------|------------------|-------|------|
| Collector-Base Voltage       | V <sub>CBO</sub> | -20   | V    |
| Collector-Emitter Voltage    | V <sub>CEO</sub> | -20   | V    |
| Emitter-Base Voltage         | V <sub>EBO</sub> | -7    | V    |
| Continuous Collector Current | I <sub>C</sub>   | -2    | A    |
| Peak Pulse Collector Current | I <sub>CM</sub>  | -3    | A    |
| Base Current                 | I <sub>B</sub>   | -300  | mA   |
| Peak Base Current            | I <sub>BM</sub>  | -1    | A    |

**Thermal Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

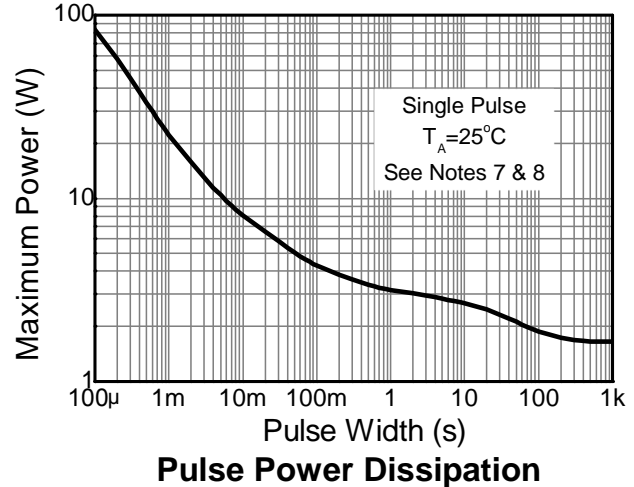
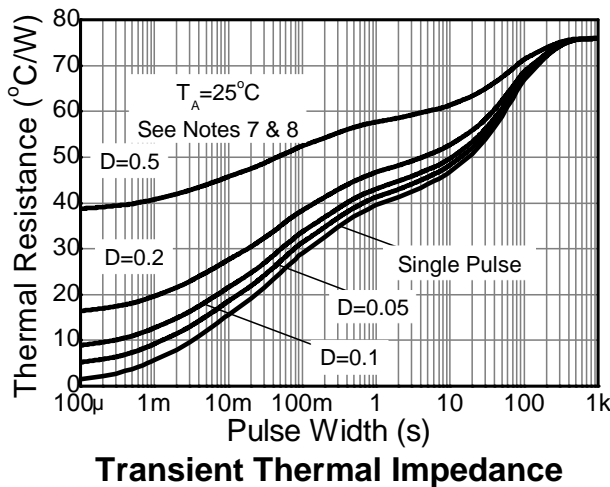
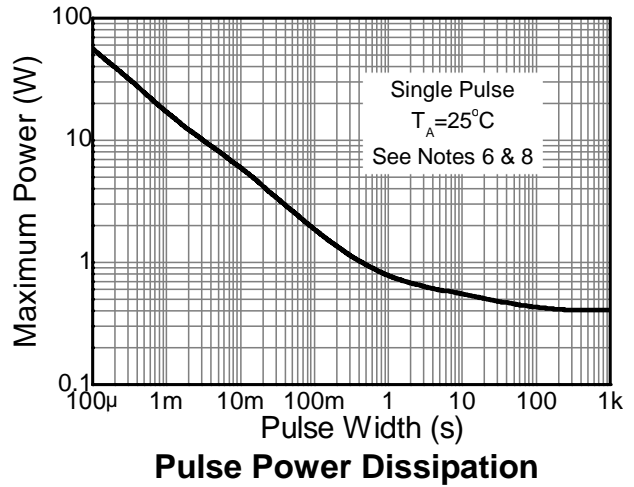
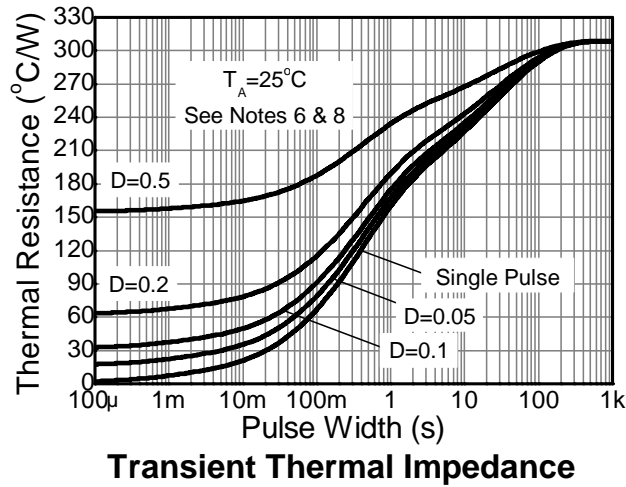
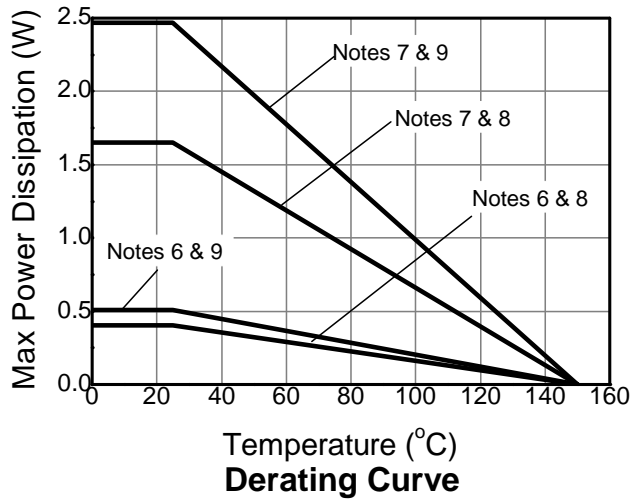
| Characteristic                          | Symbol                                 | Value       | Unit |
|---|--|-------------|------|
| Power Dissipation                       | (Notes 6 & 8)                          | 405         | mW   |
|   | (Notes 6 & 9)                          | 510         |      |
|   | (Notes 7 & 8)                          | 1650        |      |
|   | (Notes 7 & 9)                          | 2470        |      |
| Thermal Resistance, Junction to Ambient | (Notes 6 & 8)                          | 308         | °C/W |
|   | (Notes 6 & 9)                          | 245         |      |
|   | (Notes 7 & 8)                          | 76          |      |
|   | (Notes 7 & 9)                          | 51          |      |
| Thermal Resistance, Junction to Lead    | (Note 10)<br>R <sub>θJL</sub>          | 18          | °C/W |
| Operating and Storage Temperature Range | —<br>T <sub>J</sub> , T <sub>STG</sub> | -55 to +150 | °C   |

**ESD Ratings** (Note 11)

| Characteristic                             | Symbol  | Value | Unit | JEDEC Class |
|--|---------|-------|------|-------------|
| Electrostatic Discharge – Human Body Model | ESD HBM | 4,000 | V    | 3A          |
| Electrostatic Discharge – Machine Model    | ESD MM  | 400   | V    | C           |

- Notes:
6. For a device mounted with the exposed collector pads on minimum recommended pad layout that is on a single-sided 1.6mm FR-4 PCB; device is measured under still air conditions whilst operating in a steady-state.
  7. Same as note (6), except the device is mounted with the collector pad on 28mm x 28mm (8cm<sup>2</sup>) 2oz copper.
  8. For a dual device with one active die.
  9. For dual device with 2 active die running at equal power.
  10. Thermal resistance from junction to solder-point (on the exposed collector pads).
  11. Refer to JEDEC specification JESD22-A114 and JESD22-A115.

**Thermal Characteristics and Derating Information**

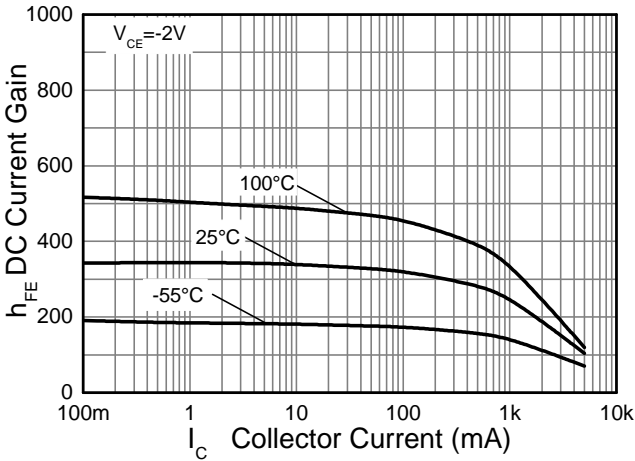


**Electrical Characteristics – Q1 & Q2** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

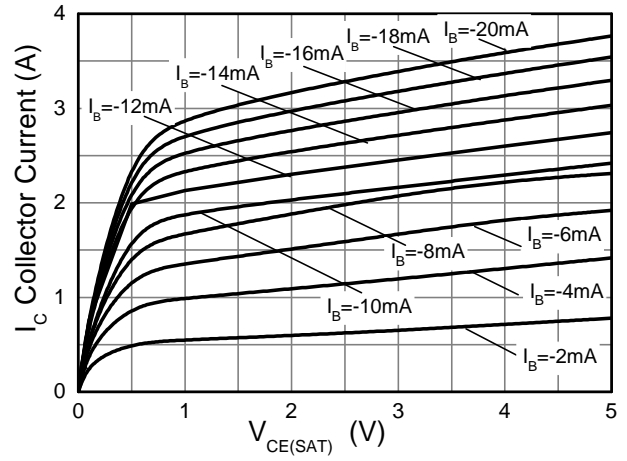
| Characteristic                                 | Symbol               | Min | Typ | Max   | Unit | Test Conditions  |
|--|----------------------|-----|-----|-------|------|--|
| Collector-Base Breakdown Voltage               | BV <sub>CB0</sub>    | -20 | —   | —     | V    | I <sub>C</sub> = -100μA  |
| Collector-Emitter Breakdown Voltage (Note 12)  | BV <sub>CEO</sub>    | -20 | —   | —     | V    | I <sub>C</sub> = -10mA   |
| Emitter-Base Breakdown Voltage                 | BV <sub>EBO</sub>    | -7  | —   | —     | V    | I <sub>E</sub> = -100μA  |
| Collector-Base Cutoff Current                  | I <sub>CBO</sub>     | —   | —   | -100  | nA   | V <sub>CB</sub> = -16V, I <sub>E</sub> = 0   |
|  |                      | —   | —   | -50   | μA   | V <sub>CB</sub> = -16V, I <sub>E</sub> = 0, T <sub>A</sub> = +150°C                        |
| Emitter-Base Cutoff Current                    | I <sub>EBO</sub>     | —   | —   | -100  | nA   | V <sub>EB</sub> = -5.6V, I <sub>C</sub> = 0  |
| DC Current Gain (Note 12)                      | h <sub>FE</sub>      | 250 | —   | —     | —    | V <sub>CE</sub> = -2V, I <sub>C</sub> = -100mA   |
|  |                      | 210 | —   | —     |      | V <sub>CE</sub> = -2V, I <sub>C</sub> = -500mA   |
|  |                      | 170 | —   | —     |      | V <sub>CE</sub> = -2V, I <sub>C</sub> = -700mA   |
|  |                      | 160 | —   | —     |      | V <sub>CE</sub> = -2V, I <sub>C</sub> = -1A  |
|  |                      | 100 | —   | —     |      | V <sub>CE</sub> = -2V, I <sub>C</sub> = -2A  |
| Collector-Emitter Saturation Voltage (Note 12) | V <sub>CE(SAT)</sub> | —   | —   | -110  | mV   | I <sub>C</sub> = -500mA, I <sub>B</sub> = -50mA  |
|  |                      | —   | —   | -220  |      | I <sub>C</sub> = -1A, I <sub>B</sub> = -50mA   |
|  |                      | —   | —   | -200  |      | I <sub>C</sub> = -0.7A, I <sub>B</sub> = -7mA  |
|  |                      | —   | —   | -390  |      | I <sub>C</sub> = -2A, I <sub>B</sub> = -200mA  |
| Equivalent On-Resistance (Note 12)             | R <sub>CE(SAT)</sub> | —   | —   | 220   | mΩ   | I <sub>E</sub> = -1A, I <sub>B</sub> = -50mA   |
| Base-Emitter Saturation Voltage (Note 12)      | V <sub>BE(SAT)</sub> | —   | —   | -1    | V    | I <sub>C</sub> = -0.5A, I <sub>B</sub> = -50mA   |
|  |                      | —   | —   | -1.1  |      | I <sub>C</sub> = -1A, I <sub>B</sub> = -50mA   |
|  |                      | —   | —   | -1.25 |      | I <sub>C</sub> = -2A, I <sub>B</sub> = -200mA  |
| Base-Emitter Turn-on Voltage (Note 12)         | V <sub>BE(ON)</sub>  | —   | —   | -0.9  | V    | V <sub>CE</sub> = -2V, I <sub>C</sub> = -0.5A  |
| Turn-On Time                                   | t <sub>ON</sub>      | —   | 60  | —     | ns   | I <sub>C</sub> = -1A, I <sub>B1</sub> = -I <sub>B2</sub> = 50mA;<br>T <sub>A</sub> = +25°C |
| Delay Time                                     | t <sub>D</sub>       | —   | 10  | —     | ns   |  |
| Rise Time                                      | t <sub>R</sub>       | —   | 50  | —     | ns   |  |

Note: 12. Measured under pulsed conditions. Pulse width ≤ 300μs. Duty cycle ≤ 2%.

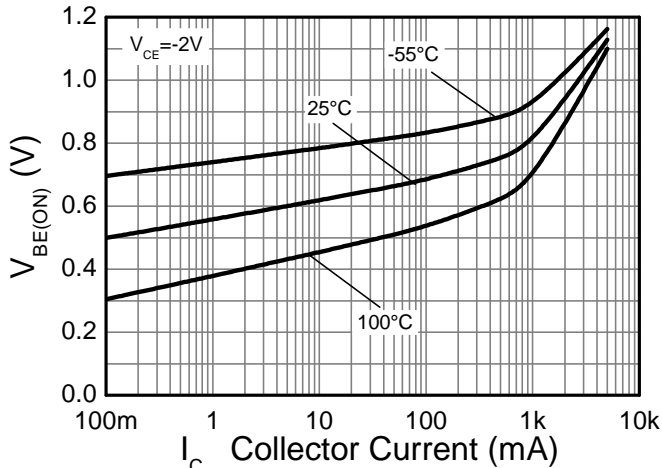
**Typical Electrical Characteristics** (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)



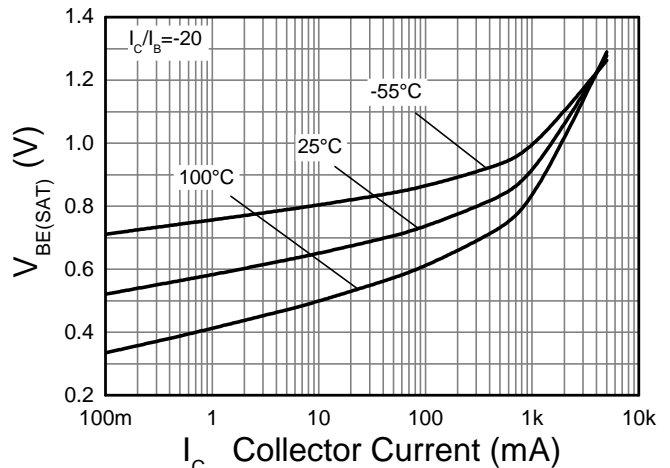
**$h_{FE}$  v Collector Current**



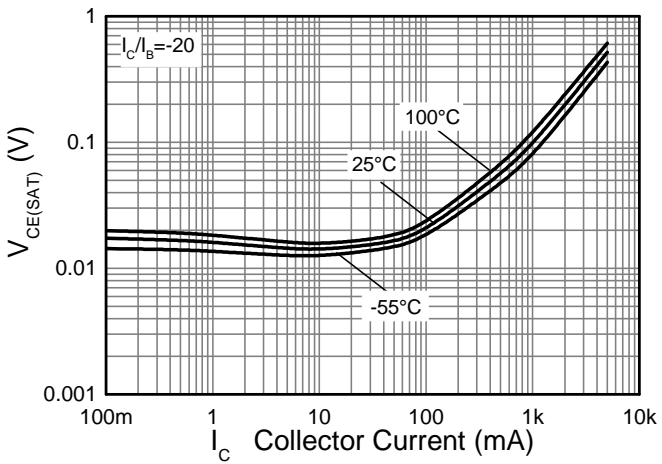
**Collector Current v  $V_{CE(SAT)}$**



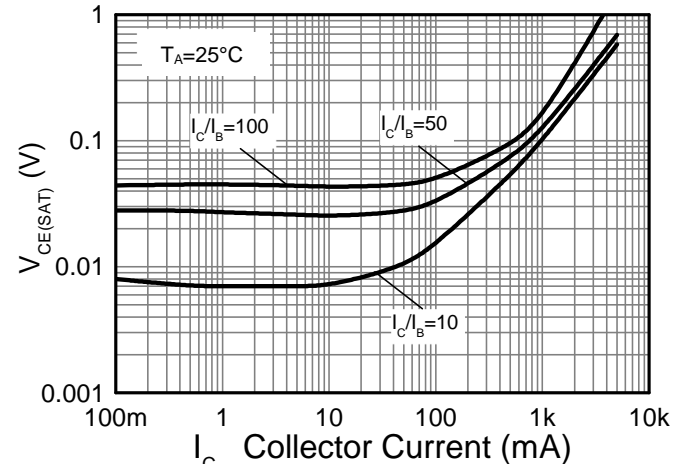
**$V_{BE(ON)}$  v Collector Current**



**$V_{BE(SAT)}$  v Collector Current**



**$V_{CE(SAT)}$  v Collector Current**

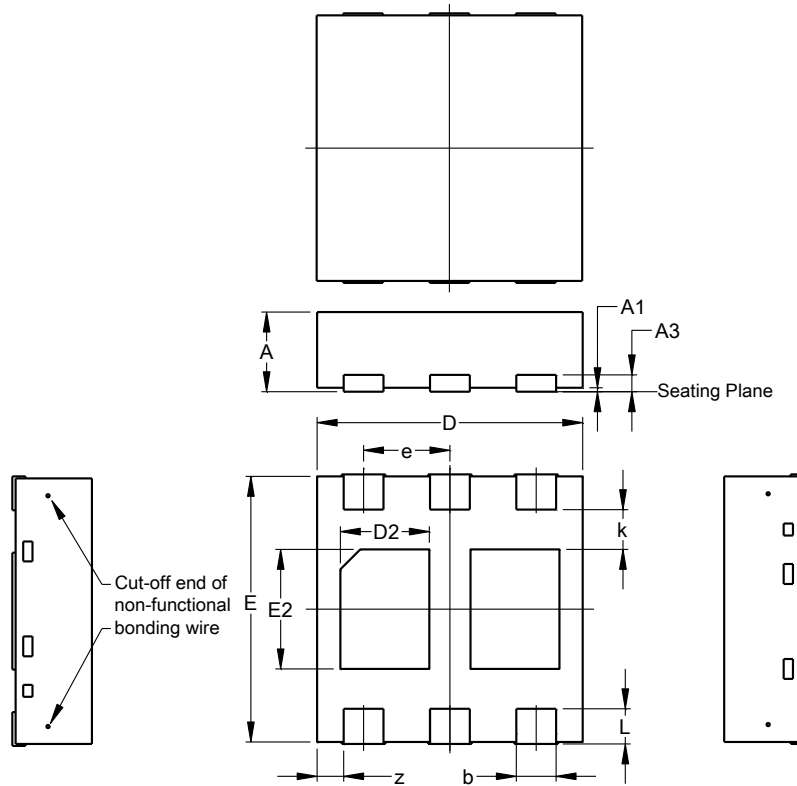


**$V_{CE(SAT)}$  v Collector Current**

**Package Outline Dimensions**

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**U-DFN2020-6 (SWP) (Type A)**

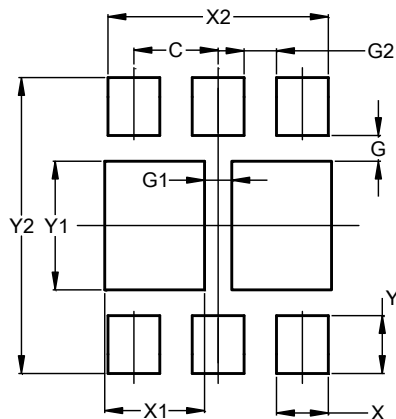


| U-DFN2020-6 (SWP)<br>(Type A) |         |      |       |
|-------------------------------|---------|------|-------|
| Dim                           | Min     | Max  | Typ   |
| A                             | 0.55    | 0.65 | 0.60  |
| A1                            | 0.00    | 0.05 | 0.03  |
| A3                            | --      | --   | 0.127 |
| b                             | 0.25    | 0.35 | 0.30  |
| D                             | 1.95    | 2.05 | 2.00  |
| D2                            | 0.57    | 0.77 | 0.67  |
| E                             | 1.95    | 2.05 | 2.00  |
| E2                            | 0.80    | 1.00 | 0.90  |
| e                             | 0.65BSC |      |       |
| k                             | 0.30BSC |      |       |
| L                             | 0.22    | 0.32 | 0.27  |
| z                             | 0.20BSC |      |       |
| <b>All Dimensions in mm</b>   |         |      |       |

**Suggested Pad Layout**

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**U-DFN2020-6 (SWP) (Type A)**



| Dimensions | Value<br>(in mm) |
|------------|------------------|
| C          | 0.650            |
| G          | 0.200            |
| G1         | 0.210            |
| G2         | 0.250            |
| X          | 0.400            |
| X1         | 0.770            |
| X2         | 1.700            |
| Y          | 0.450            |
| Y1         | 1.000            |
| Y2         | 2.300            |

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